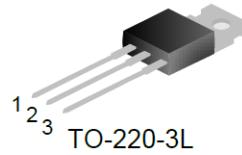


180A,100V N-CHANNEL POWER MOSFET

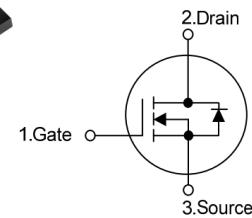
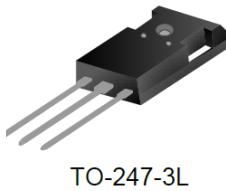
Features

- $R_{DS(on)}=2.5\text{m}\Omega$ (Typ.) @ $V_{GS}=10\text{V}, I_D=180\text{A}$
- New technology for high voltage device
- Low on-resistance
- Fast switching



Applications

- Power factor correction (PFC)
- Switched mode power supplies (SMPS)
- Uninterruptible Power Supply (UPS)



Key Performance and Package Parameters

Order codes	V_{DS}	I_D	$R_{DS(ON)}$, Typ	T_{vjmax}	Marking	Package
XD2R5S010AK1R3	100V	180A	2.5mΩ	150°C	D2R5S10AK1	TO263-2L
XD2R5S010AK1L3	100V	180A	2.5mΩ	150°C	D2R5S10AK1	TO220-3L
XD2R5S010AK1S3	100V	180A	2.5mΩ	150°C	D2R5S10AK1	TO247-3L

Absolute Maximum Ratings ($T_c= 25^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source Voltage	100	V
V_{GSS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current ($T_c=25^\circ\text{C}$)	180	A
I_{DM}	Pulsed Drain Current	720	A
P_D	Maximum Power Dissipation ($T_c=25^\circ\text{C}$) TO263, TO220 TO247	223	W
		278	
E_{AS}	Avalanche Energy, Single Pulse (note1)	961	mJ
T_J	Operating Junction Temperature Range	-55 to 150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Conditions	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Steady State)	TO263-3L	0.56	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Steady State)	TO220-3L	0.56	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Steady State)	TO247-3L	0.45	°C/W

Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}, I_{\text{DS}} = 250\mu\text{A}$	100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$	---	---	1	μA
I_{GSS}	Gate Leakage Current, Forward	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$	---	---	100	nA
	Gate Leakage Current, Reverse	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$	---	---	-100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{DS}} = 250\mu\text{A}$	2.2	---	3.8	V
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}} = 10\text{V}, I_{\text{DS}} = 90\text{A}$	---	2.5	3.0	$\text{m}\Omega$
Q_g	Total Gate Charge	$V_{\text{DD}} = 50\text{V}$ $V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 90\text{A}$	---	171	---	nC
Q_{gs}	Gate-Source Charge		---	61	---	nC
Q_{gd}	Gate-Drain Charge		---	47	---	nC
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}} = 50\text{V}, V_{\text{GS}} = 10\text{V}$ $I_{\text{D}} = 90\text{A}, R_{\text{G}} = 3\Omega$	---	44	---	ns
t_r	Turn-on Rise Time		--	70	--	ns
$t_{\text{d(off)}}$	Turn-off Delay Time			99	---	ns
t_f	Turn-off Fall Time		---	46	---	ns
C_{iss}	Input Capacitance	$V_{\text{DS}} = 50\text{V}$ $V_{\text{GS}} = 0\text{V}$ $f = 1\text{MHz}$	---	10542	---	pF
C_{oss}	Output Capacitance		---	1264	---	pF
C_{rss}	Reverse Transfer Capacitance		---	38	---	pF

Diode Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V_{SD}	Diode Forward Voltage	$I_{\text{s}} = 90\text{A}, V_{\text{GS}} = 0\text{V}$	---	---	1.4	V
t_{rr}	Diode Reverse Recovery Time	$I_{\text{s}} = 90\text{A}, V_{\text{GS}} = 0\text{V}$ $dI_F/dt = 100\text{A}/\mu\text{s}$	---	97	---	ns
Q_{rr}	Diode Reverse Recovery Charge		---	0.28	---	μC

Notes:

- 1.
- $V_{\text{DD}} = 80\text{V}$
- ,
- $L = 0.5\text{mH}$
- ,
- $R_{\text{G}} = 25\Omega$
- , starting,
- $T_J = 25^\circ\text{C}$
- .

Typical Characteristics

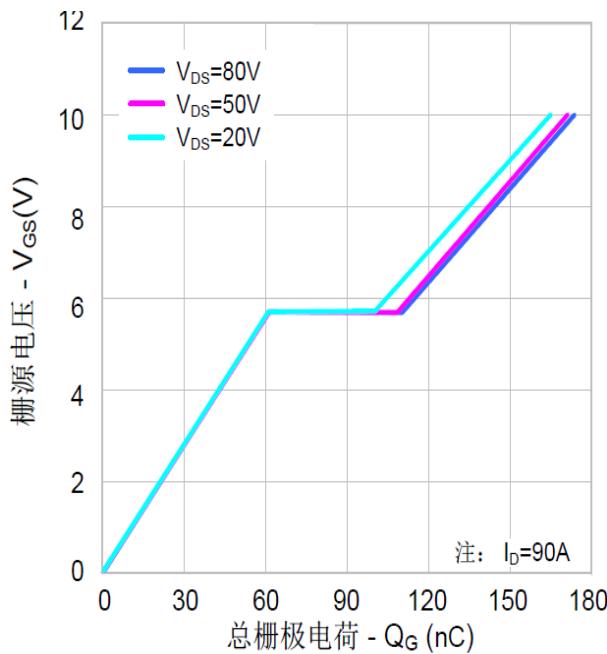


Fig.1 Gate Charge

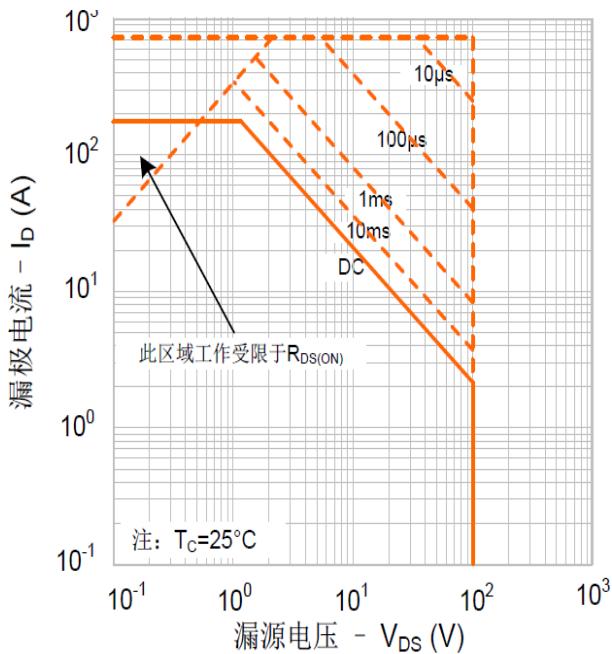


Fig.2 Safe Operation Area

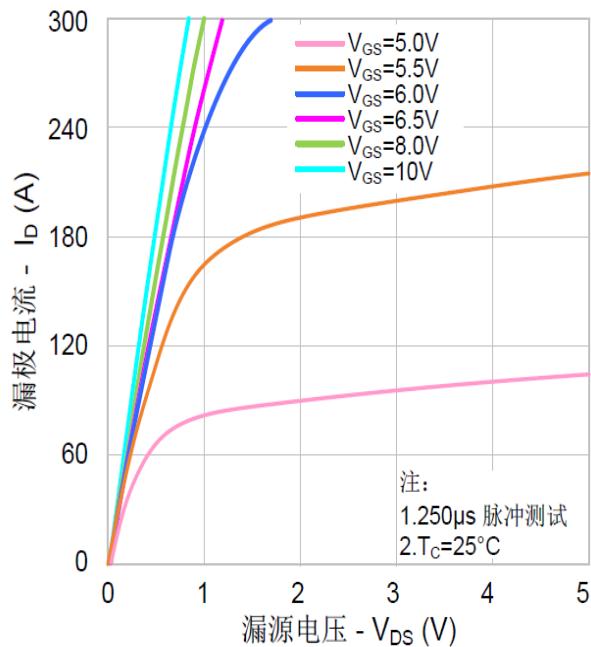


Fig.3 Output Characteristics

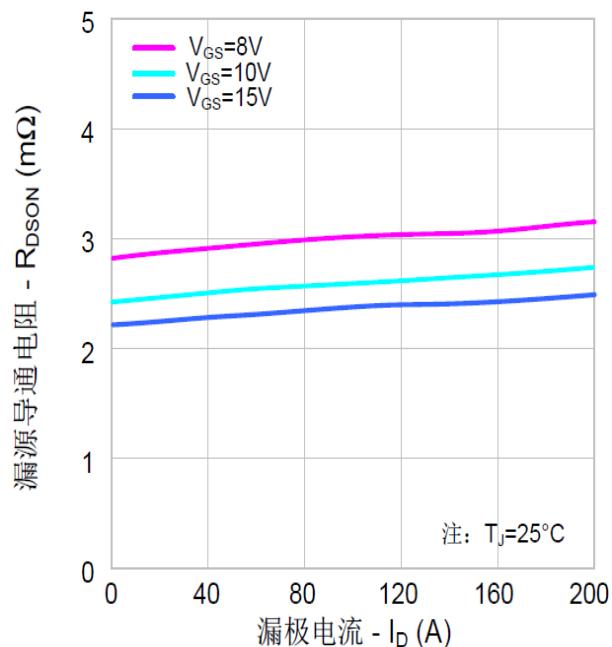


Fig.4 Drain-Source On Resistance

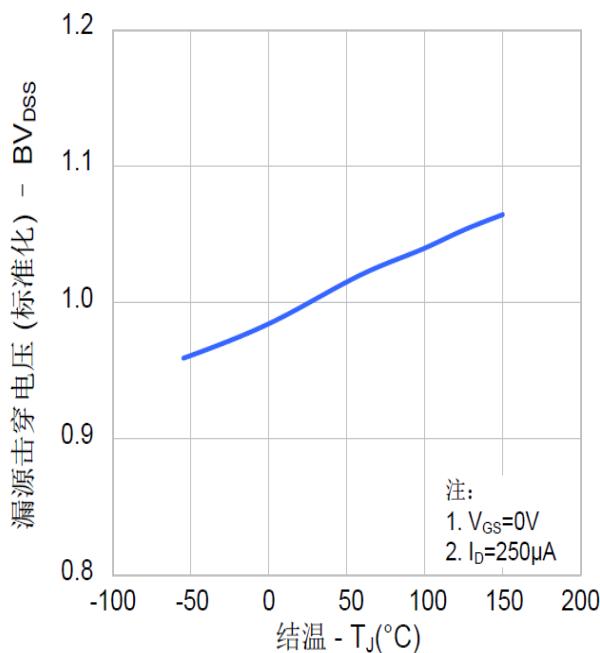


Fig.5 Drain-Source Breakdown Voltage

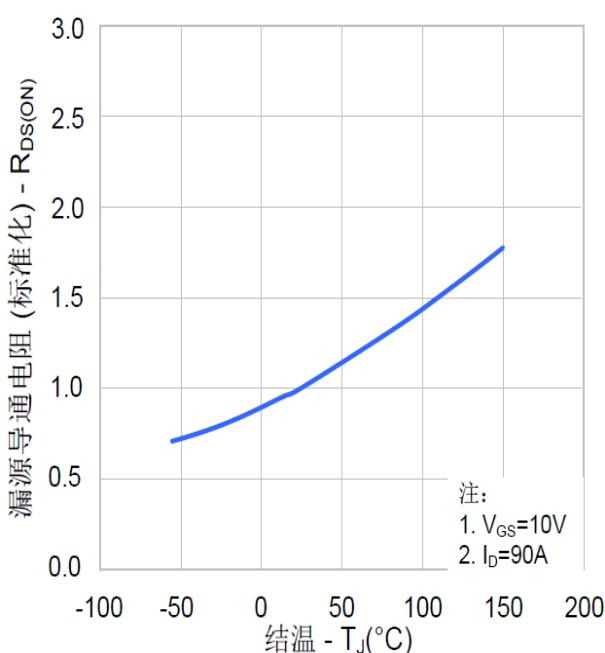


Fig.6 Drain-Source On Resistance

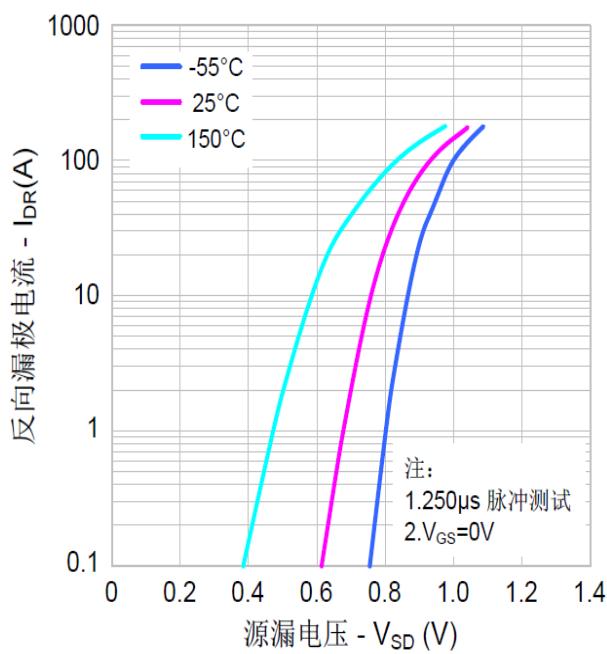


Fig.7 Source-Drain Diode Forward Current

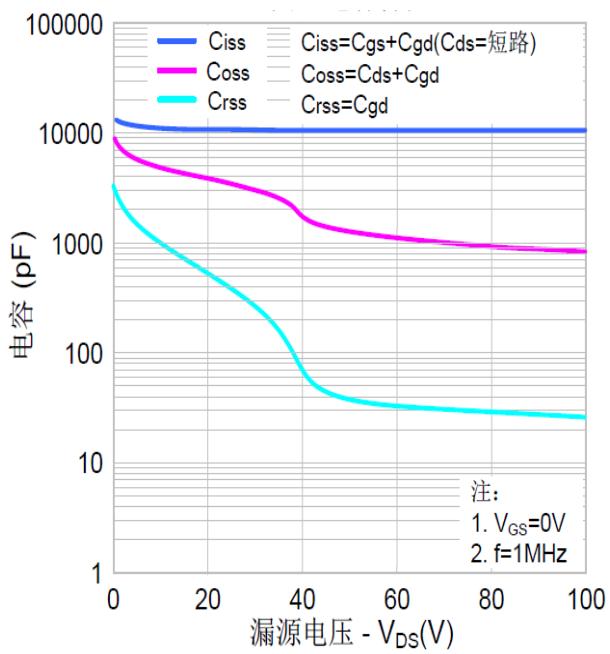


Fig.8 Capacitance

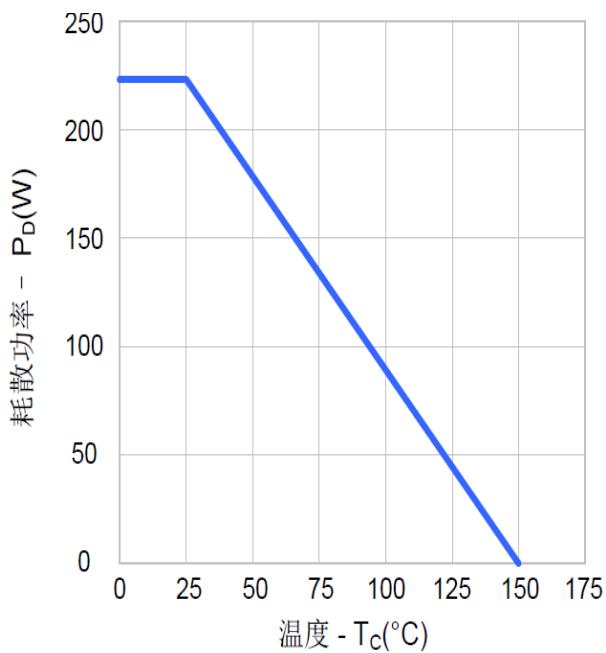


Fig.9 Power Dissipation(TO220,TO263)

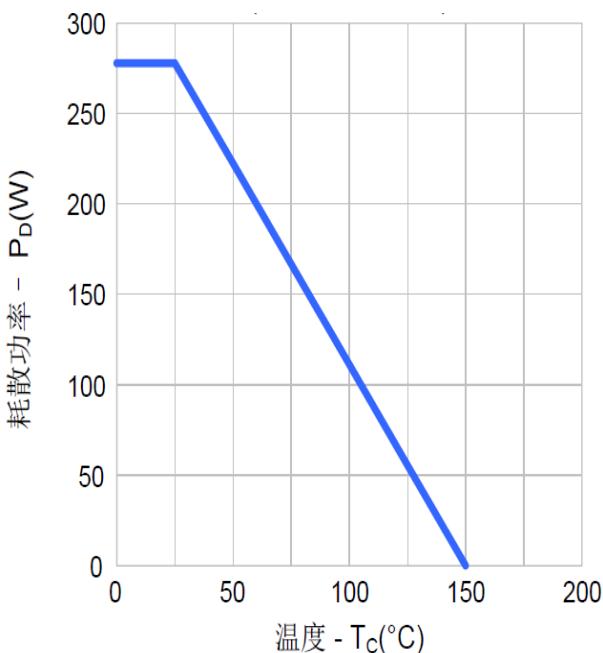
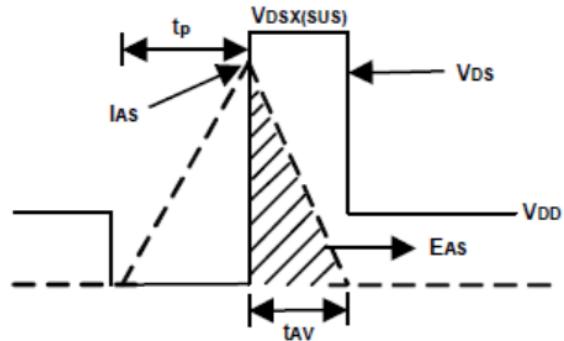
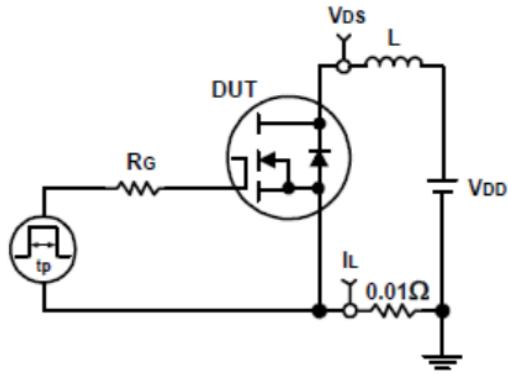
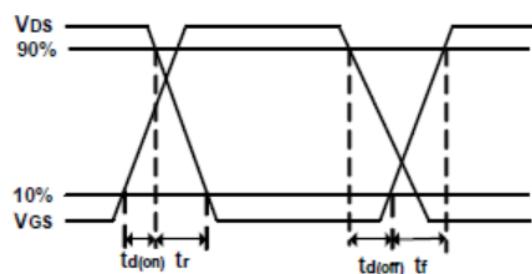
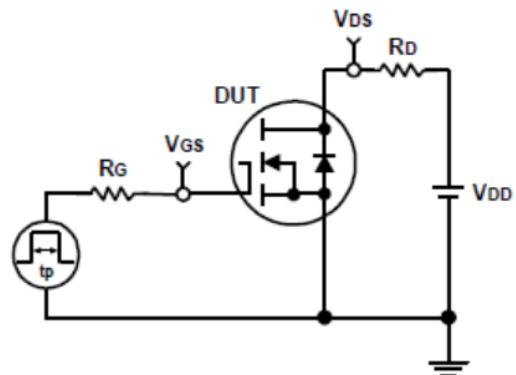


Fig.8 Power Dissipation(TO247)

Avalanche Test Circuit and Waveforms

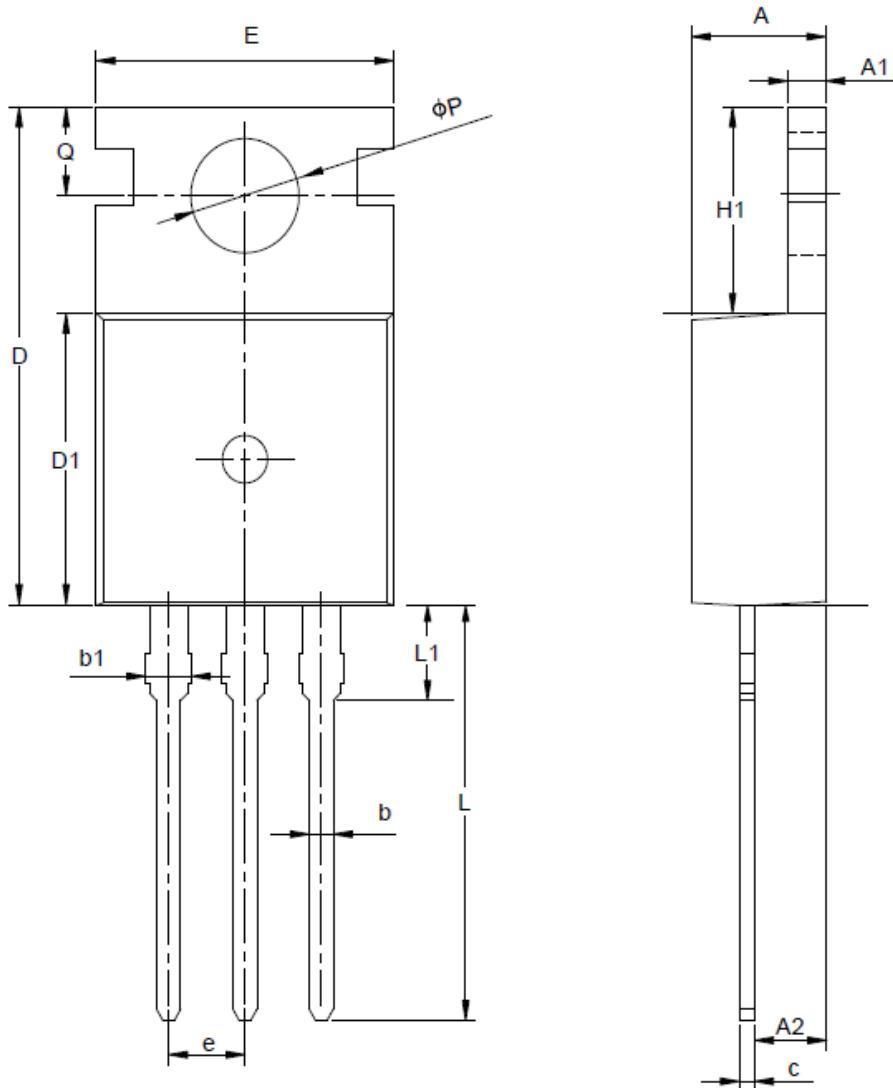


Switching Time Test Circuit and Waveforms

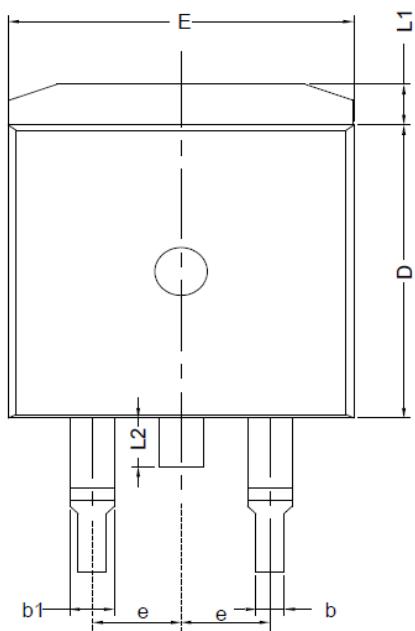


Package Information

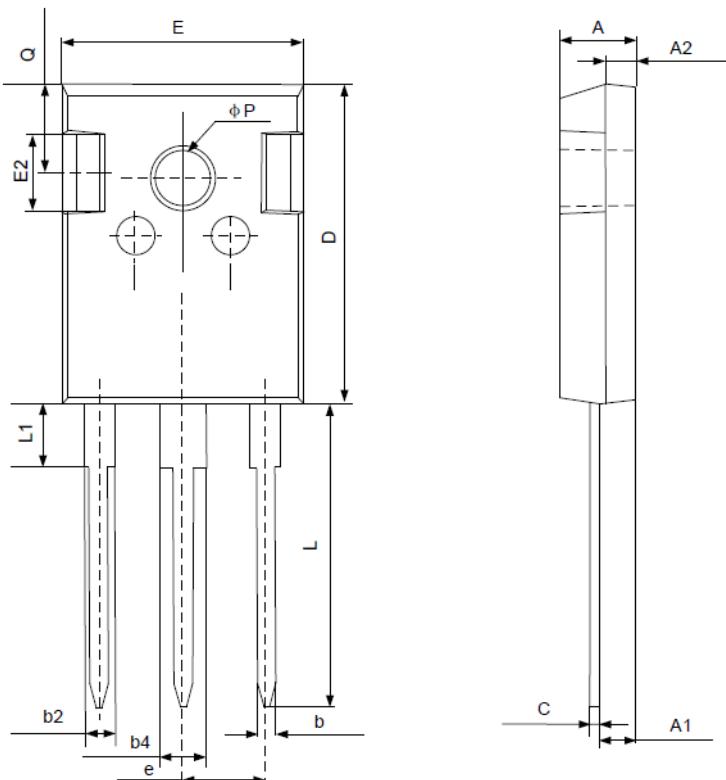
TO-220-3



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
ϕP	3.40	3.70	3.90
Q	2.60	—	3.20

TO-263-2


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.57	4.72
A1	0	0.10	0.25
b	0.71	0.81	0.91
b1	1.17	—	1.50
c	0.30	—	0.60
c2	1.17	1.27	1.37
D	8.50	—	9.35
E	9.80	—	10.45
e	2.54BSC		
H	14.70	—	15.75
L	2.00	2.30	2.74
L1	1.12	1.27	1.42
L2	—	—	1.75

TO247-3


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.59
A2	1.85	2.00	2.15
b	1.11	—	1.36
b2	1.91	—	2.25
b4	2.91	—	3.25
c	0.51	—	0.75
D	20.80	21.00	21.30
E	15.50	15.80	16.10
E2	4.40	5.00	5.20
e	5.44 BSC		
L	19.72	19.92	20.22
L1	—	—	4.30
Q	5.60	5.80	6.00
P	3.40	—	3.80